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- Asynchronous Communication Between Data Buses
- Local Bus-Latch Capability
- True Logic
- Package Options Include Plastic Small-Outline Packages, Ceramic Chip Carriers, and Standard Plastic and Ceramic 300-mil DIPs

description

These quadruple bus transceivers are designed for asynchronous communications between data buses. The control function implementation allows for maximum flexibility in timing. These devices allow data transmission from the A bus to the B bus or from the B bus to the A bus depending upon the logic levels at the output-enable (OEBA and OEAB) inputs. The output-enable inputs can be used to disable the device so that the buses are effectively isolated.

The dual-enable configuration gives the quadruple bus transceivers the capability to store data by simultaneous enabling of OEBA and OEAB. Each output reinforces its input in this transceiver configuration. Thus, when both control inputs are enabled and all other data sources to the two sets of bus lines are at high impedance, both sets of bus lines (eight in all) remain at their states. The 4-bit codes appearing on the two sets of buses will be identical for the 'F243.

The SN54F243 is characterized for operation over the full military temperature range of -55° C to 125°C. The SN74F243 is characterized for operation from 0°C to 70°C.

FUNCTION TABLE							
INP	UTS	FUNCTION					
OEAB	OEBA						
L	L	A to B					
н	Н	B to A Isolation					
н	L						
L	Н	Latch A and B (A = B)					



	1	14	J ∧CC
NC [2		J VCC] OEBA
A1 [3	12] NC
A2 [A3 [4	11] B1
A3 [5	10	B2
A4 [6	9	B3
GND [7	8	B4

SN54F243 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

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logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



Pin numbers shown are for the D, J, and N packages.



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V _{CC} Input voltage range, V _I (see Note 1) . Input current range Voltage range applied to any output in Voltage range applied to any output in Current into any output in the low state	the disabled or power-off state the high state	
Operating free-air temperature range: Storage temperature range	SN54F243 SN74F243	0°C to 70°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input voltage ratings may be exceeded provided the input current ratings are observed.

recommended operating conditions

		SN54F243			SN74F243			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.8			0.8	V
Iк	Input clamp current			-18			-18	mA
ЮН	High-level output current		- 12				- 15	mA
IOL	Low-level output current	48				64	mA	
TA	Operating free-air temperature	-55 125		0		70	°C	



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		S	SN54F243			SN74F243			
				MIN	TYP†	MAX	MIN	TYP†	MAX	UNIT	
VIK		V _{CC} = 4.5 V,	lı = –18 mA			-1.2			-1.2	V	
			I _{OH} = – 3 mA	2.4	3.3		2.4	3.3			
V		$V_{CC} = 4.5 V$	I _{OH} = - 12 mA	2	3.2					v	
∨он			I _{OH} = - 15 mA				2	3.1			
		V _{CC} = 4.75 V,	IOH = - 3 mA				2.7				
			I _{OL} = 48 mA		0.38	0.55				V	
VOL		$V_{CC} = 4.5 V$	I _{OL} = 64 mA					0.42	0.55		
1.	A or B port	V _{CC} = 5.5 V	Vj = 5.5 V			1			1	A	
lj –	Control inputs		V _I = 7 V			0.1			0.1	mA	
1	A or B port‡	V _{CC} = 5.5 V, V _I = 27.7' v	\/. Q7\/			70			70	۵	
IН	Control inputs		v = 2:r v		20			20	μA		
I _{IL} ‡		V _{CC} = 5.5 V,	V _I = 0.5 V			- 1			- 1.6	mA	
los§		V _{CC} = 5.5 V,	V _O = 0	-100		-225	-100		-225	mA	
ICC		V _{CC} = 5.5 V, See Note 2	Outputs high		64	80		64	80		
				Outputs low		64	90		64	90	mA
			Outputs disabled		71	90		71	90		

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

 \ddagger For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current.

§ Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

NOTE 2: ICC is measured either with all transceivers enabled in only one direction or all transceivers disabled.

switching characteristics (see Note 3)

PARAMETER	FROM (INPUT)	то (оитрит)	V _{CC} = 5 V, C _L = 50 pF, R _L = 500 Ω, T _A = 25°C			$V_{CC} = 4.5 V \text{ to } 5.5 V,$ $C_{L} = 50 \text{ pF},$ $R_{L} = 500 \Omega,$ $T_{A} = \text{MIN to MAX}$				UNIT
				′F243			F243	SN74F243		
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
^t PLH	A or B	B or A	1.7	3.6	5.2	1.2	6.5	1.2	6.2	ns
^t PHL		BUIA	1.7	3.6	5.2	1.2	8.5	1.2	6.5	115
^t PZH	Enable	A or B	1.2	3.9	5.7	1.2	8	1.2	6.7	
^t PZL	Enable	AUB	1.2	5.4	7.5	1.2	10.5	1.2	8.5	ns
^t PHZ	Disable		1.2	4.1	6	1	7.5	1	7	
^t PLZ		A or B	2	4.5	6	2	8.5	2	7	ns

¶ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. NOTE 3: Load circuits and waveforms are shown in Section 1.



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